

A
BACHELOR'S DEGREE IN TELECOMMUNICATION ENGINEERING

Bachelor's Thesis

ACADEMIC COURSE 2021/2022

Tree Inspection Kit handheld device

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DEPARTMENT:

Electronics and Computer Technology



UNIVERSIDAD
DE GRANADA



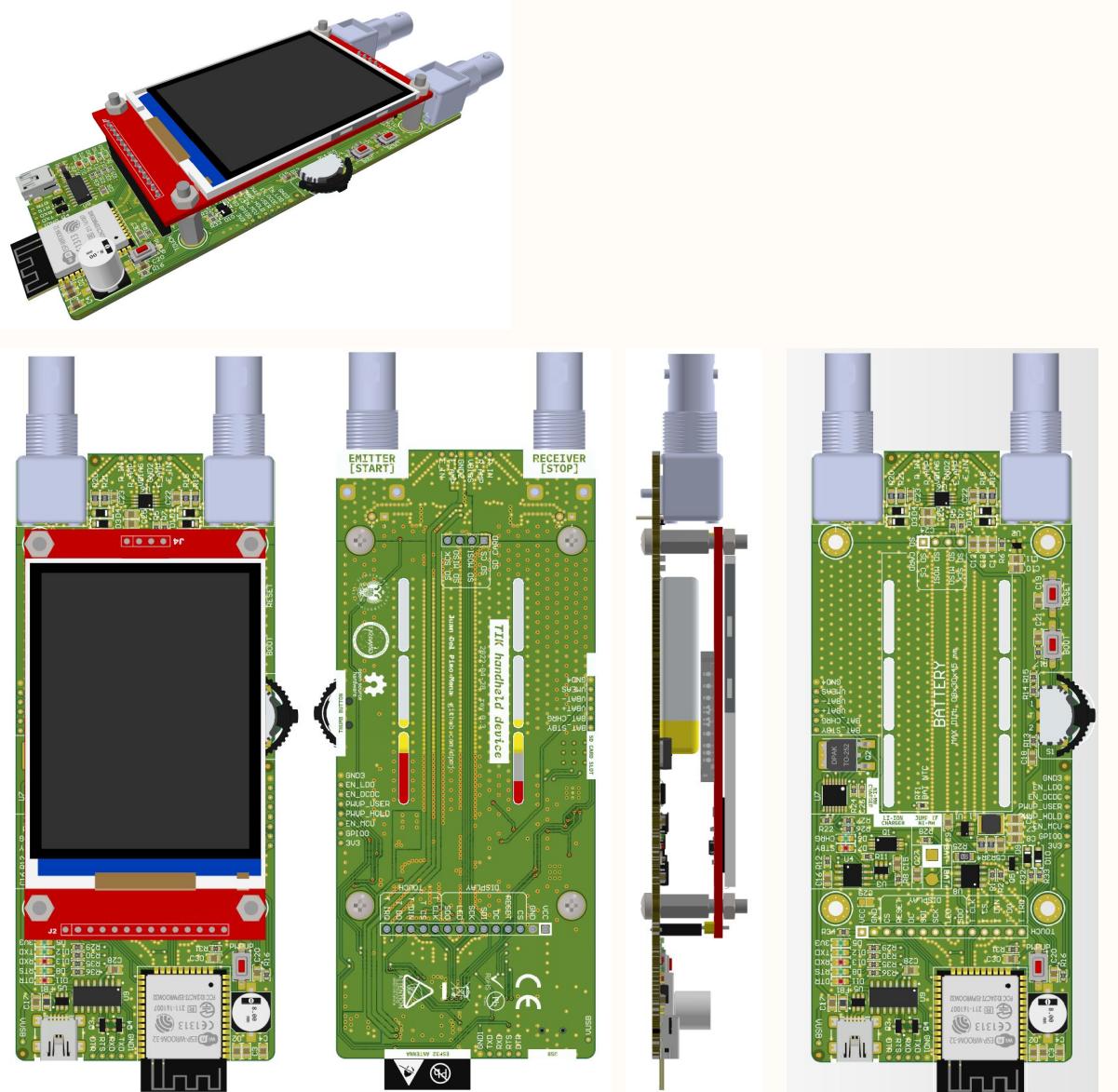
Project title: **TIK_HandheldDevice.PrjPcb**

Date: **2022-04-28** Revision: **0.3**

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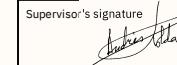
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Tree Inspection Kit handheld device

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Sheet title: **Introduction and PCB renders**
Project title: **TIK_HandheldDevice.PxjPcb**

Designer: **Juan Del Pino Mena**

Date: **2022-04-28** Revision: **0.3**

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A

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Revision 0.3 | 2022-04-27

NEW

- Changed rotary encoder vertical for horizontal, side-placed, SMD type multipurpose 'thumb button'.
- Added logos and other graphs to the PCB.
- Added a explanation of chosen trace width.
- Full PCB component placement and routing, with no important DRC messages
- Added some silkscreen logos to the back of the PCB, as well as port markings, information and regulatory logos

FIXED

- Changed numerical test point designators to net/rail names, to be quickly identified.
- Changed LEDs footprints from 0603 to 0805
- Corrected a faulty connection on the DW01A Lithium battery protection IC.
- The MCU has no longer the possibility of cutting battery charge. This is because ENABLE signals worked on 5V logic level and could cause damage to the ESP32.

REVISION 0.1 | 2022-04-01

NEW

- TFT LCD / SD card connections.
- First adequation circuit iteration
- LiPo battery charger with TP4056
- Auto programming circuit.

B

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Revision 0.2 | 2022-04-23

NEW

- New schematic hierarchy and system's block diagram.
- Initial PCB layout
- Added a rotary encoder (vertical). Library contains a 90-degree rotary encoder alternative.
- Added a new alternative Ni-MH charger circuit.
- Added footprints for all neccessary components to the PCB Library.
- Added explanatory footprints and photos to schematic ICS.
- Added board mounting holes (making use of the TFT LCD module mounting hole positions)
- Added test points
- Added fiducials
- Added a power-up button
- Added net classes and parameter sets to most important ones: power, digital communications, analog signals.

FIXED

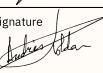
- Removed errors in the lithium charger
- Removed errors in the adequation circuit
- Changed ESD USB Protection IC.
- Changed some adequation circuit values and made topology more clear.
- Revised all passive components values and sizes to match existing component disponibility.
- Corrected various pin definitions from the ESP32-WROOM-32D symbol

C

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Revision history

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Sheet title: Changelog

Project title: TIK_HandheldDevice.PjPcb

Desginer: Juan Del Pino Mena

Date: 2022-04-28 Revision: 0.3

Sheet 3 of 18

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Maximum SPI traces length

Wavelength Calculator

Input Method	Wavelength Information
<input type="radio"/> Period	<input type="radio"/> Er Effective Information
<input checked="" type="radio"/> Frequency	<input type="radio"/> Speed of Light

Frequency: **80 MHz** Units: MHz kHz Hz

Er Eff: **2,8905**

Er Eff Calculator

$\lambda = \frac{C}{f * \sqrt{(ErEff)}}$

Note: Enter an Er Eff of 1 for wavelength in air.

Wavelength Divide: **1/20**

1/20 Wave Length: **11.02083 cm**

Bandwidth & Max Conductor Length

Input Method	Speed of Light
<input type="radio"/> Signal Risetime	<input type="radio"/> Frequency
<input checked="" type="radio"/> Frequency	<input type="radio"/> Units

f Units: MHz kHz Hz

Frequency: **80 MHz**

Frequency Domain Method

Full Wavelength (In Air): **374.74057 cm**

Lambda Divide by Factor: **1/20**

Maximum Conductor Length: **18.73703 cm**

Maximum Analog traces length

Wavelength Calculator

Input Method	Wavelength Information
<input type="radio"/> Period	<input type="radio"/> Er Effective Information
<input checked="" type="radio"/> Frequency	<input type="radio"/> Speed of Light

Frequency: **100 KHz** Units: MHz kHz Hz

Er Eff: **3,0832**

Er Eff Calculator

$\lambda = \frac{C}{f * \sqrt{(ErEff)}}$

Note: Enter an Er Eff of 1 for wavelength in air.

Wavelength Divide: **1/20**

1/20 Wave Length: **8536.69684 cm**

Analog signal trace impedance

Conductor Impedance

Conductor Width (W)	Formula Restrictions:
0,8 mm	$0.1 < W/H < 2.0$
Conductor Height (H)	$T = 53\mu m$
1,5 mm	<input type="checkbox"/> Help
Conductor Gap (G)	0,254 mm

W/H = 0.533

Z₀: **60.6257 Ohms**

Power traces conductor characteristics (DC)

0.5 mm wide traces

Conductor Characteristics

Solve For	<input type="radio"/> Amperage	<input type="radio"/> No
Parallel Conductors?	<input checked="" type="radio"/> No	<input type="radio"/> Yes

Plane Present? No Yes

Conductor Width: **0,5 mm**

Conductor Length: **1 mm**

PCB Thickness: **1,6 mm**

Frequency: DC

Distance to Plane: **1,5 mm**

Plating Thickness: Bare PCB
 18um
 35um
 53um
 70um
 88um
 106um
 124um
 142um
 178um

Units: Imperial Metric

Substrate Options: **FR-4 STD**

Material Selection: **FR-4 STD**

Temp Rise (°C): **4,6** Tg (°C): **130**

Temp in (°F) = 18.0

Ambient Temp (°C): **25**

Temp in (°F) = 77.0

Plane Thickness: **0,5oz / 1oz**

2oz

Plating Thickness: Bare PCB
 18um
 35um
 53um
 70um
 88um
 106um
 124um
 178um

Units: Imperial Metric

Substrate Options: **FR-4 STD**

Material Selection: **FR-4 STD**

Temp Rise (°C): **4,6** Tg (°C): **130**

Temp in (°F) = 18.0

Ambient Temp (°C): **25**

Temp in (°F) = 77.0

Plane Thickness: **0,5oz / 1oz**

2oz

Information: Total Copper Thickness 70 um Via Thermal Resistance N/A

IPC-2152 with modifiers mode Etch Factor: 1:1

Power Dissipation: **0.00397 Watts** Conductor DC Resistance: **0.00065 Ohms**

Power Dissipation in dBm: **5.9921 dBm** Conductor Cross Section: **0.0301 Sq.mm**

Voltage Drop: **0.0016 Volts** Conductor Current: **2.4647 Amps**

Information: Total Copper Thickness 70 um Via Thermal Resistance N/A

Print Solve!

0.35 mm wide traces

Conductor Characteristics

Solve For	<input type="radio"/> Amperage	<input type="radio"/> No
Parallel Conductors?	<input checked="" type="radio"/> No	<input type="radio"/> Yes

Plane Present? No Yes

Conductor Width: **0,35 mm**

Conductor Length: **1 mm**

PCB Thickness: **1,6 mm**

Frequency: DC

Distance to Plane: **1,5 mm**

Plating Thickness: Bare PCB
 18um
 35um
 53um
 70um
 88um
 106um
 124um
 178um

Units: Imperial Metric

Substrate Options: **FR-4 STD**

Material Selection: **FR-4 STD**

Temp Rise (°C): **4,6** Tg (°C): **130**

Temp in (°F) = 18.0

Ambient Temp (°C): **25**

Temp in (°F) = 77.0

Plane Thickness: **0,5oz / 1oz**

2oz

Plating Thickness: Bare PCB
 18um
 35um
 53um
 70um
 88um
 106um
 124um
 178um

Units: Imperial Metric

Substrate Options: **FR-4 STD**

Material Selection: **FR-4 STD**

Temp Rise (°C): **4,6** Tg (°C): **130**

Temp in (°F) = 18.0

Ambient Temp (°C): **25**

Temp in (°F) = 77.0

Plane Thickness: **0,5oz / 1oz**

2oz

Information: Total Copper Thickness 70 um Via Thermal Resistance N/A

IPC-2152 with modifiers mode Etch Factor: 1:1

Power Dissipation: **0.00371 Watts** Conductor DC Resistance: **0.00100 Ohms**

Power Dissipation in dBm: **5.6940 dBm** Conductor Cross Section: **0.0196 Sq.mm**

Voltage Drop: **0.0019 Volts** Conductor Current: **1.9218 Amps**

Information: Total Copper Thickness 70 um Via Thermal Resistance N/A

Print Solve!

Via characteristics

Via Characteristics

Via Hole Diameter: **0,3 mm**

Internal Pad Diameter: **0,6 mm**

Ref Plane Opening Diam: **1,016 mm**

Via Height: **1,6 mm**

Via Plating Thickness: **0,035 mm**

IPC-2152 with modifiers mode

Via Capacitance: **0.5893 pF** Via DC Resistance: **0.00086 Ohms** Power Dissipation: **0.00326 Watts**

Via Inductance: **1.2993 nH** Resonant Frequency: **5751.849 MHz** Conductor Cross Section: **0.0368 Sq.mm**

Via Impedance: **46.956 Ohms** Step Response: **30.4373 ps** Via Current: **1.9514 Amps**

Trace & via characteristics

Trace width based on results from PCB Toolkit by Saturn PCB Design INC.

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**TO-DO: EXPLAIN DATA.
CROP SOME
SCREENSHOTS**

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Sheet title: **Trace width design**

Project title: **TIK_HandheldDevice.PjPcb**

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Designer: **Juan Del Pino Mena**

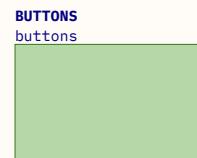
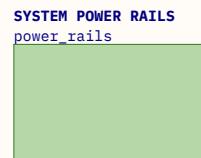
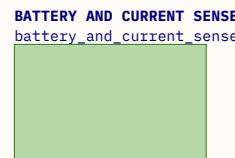
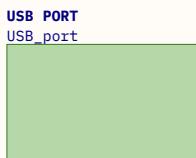
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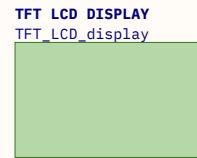
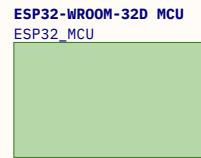
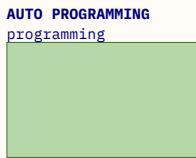
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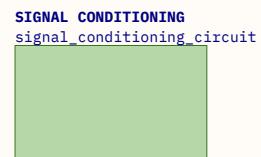
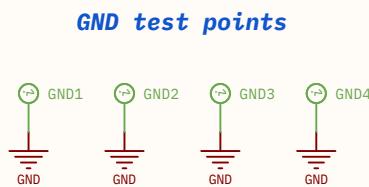
B

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C

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Block diagram

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TO-DO: ARROWS
INDICATING WHERE
SIGNALS GO

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Sheet title: **Block diagram**

Project title: **TIK_HandheldDevice.PrjPcb**

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Designer: **Juan Del Pino Mena**

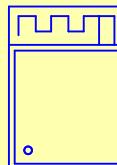
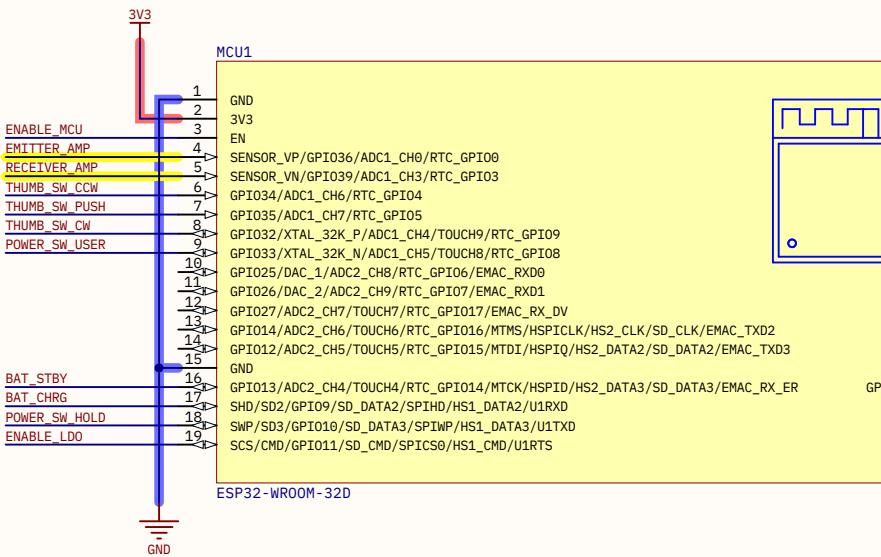
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Matched Net Lengths [Tolerance = 1mm]

SPI

Matched Net Lengths [Tolerance = 1mm]

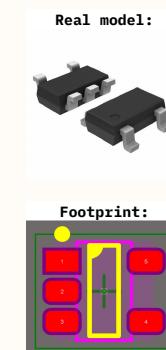
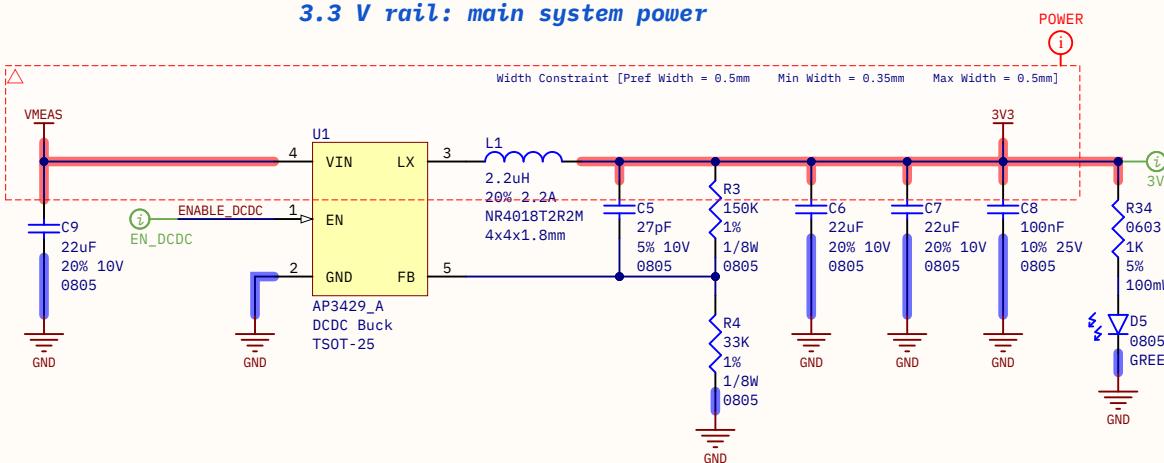
UART

Matched Net Lengths [Tolerance = 1mm]

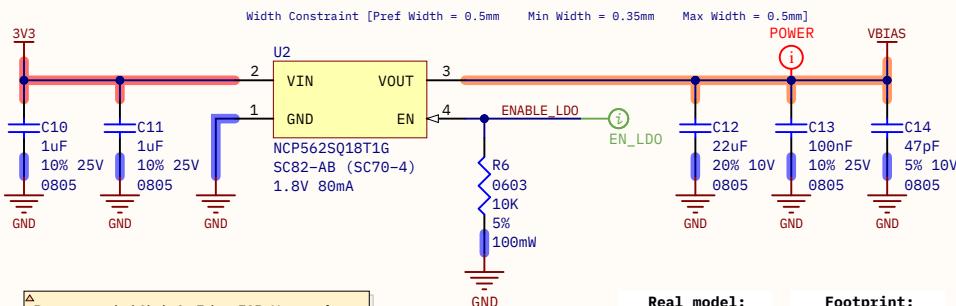
I2C

Typical Application Circuit. [AP3429/A datasheet, page 2] with some values modified as needed and/or part availability. Capacitors should be placed close to the chip and circuit should be traced in short loops. Feedback voltage V_{FB} is 0.6 V const.

Resistors are adjusted as a voltage divider. So, if 3.3V are needed at the converter output: $V_{FB} = 0.6V = V_{out} \cdot (R2)/(R1+R2) \rightarrow R2 = 2/9 \cdot R1$. Resistor values must be high (kOhms) in order to maintain a low power consumption on the feedback circuit.



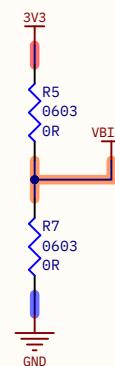
1.8 V rail: Vbias for signal conditioning circuit



Recommended C_{in} is 1 μ F, low ESR. Usage of multiple input capacitors to reduce ESR and ESL. There are no recommended values for C_{out} but these caps should probe more than enough to have low ESR and reduce ripple at a wide frequency range. Datasheet specifies a typical 100 μ Vrms noise on V_{out} , somewhat high.

Optional 1V8 rail bypass jumpers

IMPORTANT: 1V8 rail is bypassable by soldering these optional 0-ohm resistors. This is for experimenting with different voltages and if it affects the overall performance of the acquisition circuit. Do NOT connect both OR resistors at the same time or it will jump VCC and GND. And keep the LDO disabled at all times.



This can also be used to insert a voltage divider. i.e.: if you want to reduce the rail voltage to $V_{CC}/2$ you only have to add two ≥ 10 KOhm 0603 resistors. Just keep in mind that voltage won't be as stable as in a LDO as it will be greatly dependent on the load impedance.

If you do this, populate the LDO's output caps, so VBIAS it behaves as a small-signal GND.

Power rails

Battery DC/DC step-down converter and Vbias for signal conditioning circuit.

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Sheet title: *
Project title: TIK_HandheldDevice.PjPcb

Designer: Juan Del Pino Mena

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Battery charging circuit variants

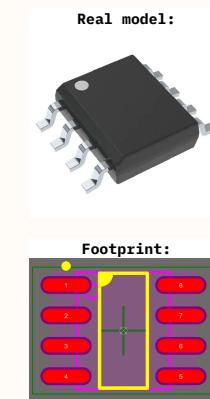
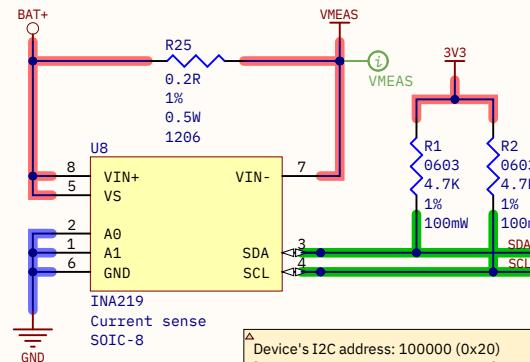
BATTERY CHARGER [VARIANT #1: NiMH]
battery_charger_ni_mh



BATTERY CHARGER [VARIANT #2: LI-ION]
battery_charger_li-ion

Two circuit variants are implemented BUT NOT USED SIMULTANEOUSLY. Only one must be populated at a time.
The usage of one over the other will come by component disponibility.

Battery output current sense and voltage monitor



Battery connector. Charger selection jumper. Battery thermistor

Width Constraint [Pref Width = 0.5mm Min Width = 0.35mm Max Width = 0.5mm]

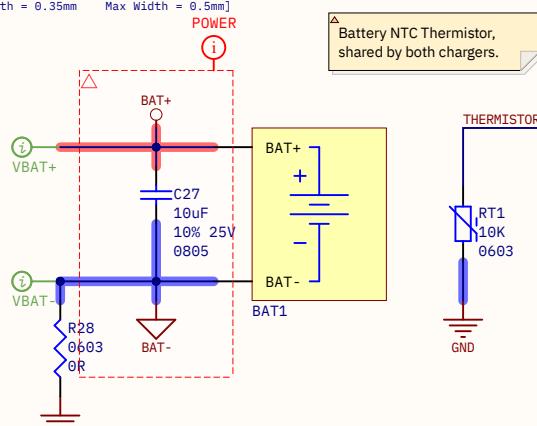
IMPORTANT: 0-Ohm jumper for charger selection:

The battery share the connector between the 2 possible chargers.

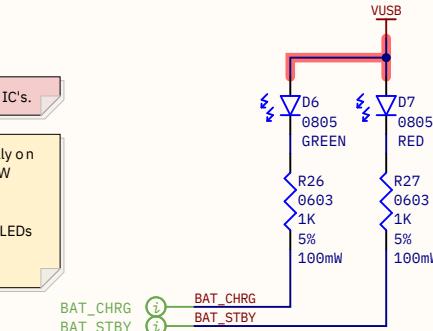
However, on the Lithium one BAT- is not connected to the system GND for protection; but in the case of the NiMH one it is.

So, to avoid shorting BAT- and GND on the Li-Ion charger, DO NOT place the 0-ohm jumper.

On the other hand if you are using the NiMH charger solder you MUST use the jumper.



Charging status indicator



Battery and current sense

Two circuit variants that will be implemented but not used simultaneously. The usage of one over the other will come by component disponibility. INA219 current sensor is independent and common for both systems.

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Sheet title: **Battery and current sense**

Project title: **TIK_HandheldDevice.PjPcb**

Designer: **Juan Del Pino Mena**

Date: **2022-04-28**

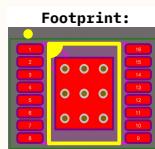
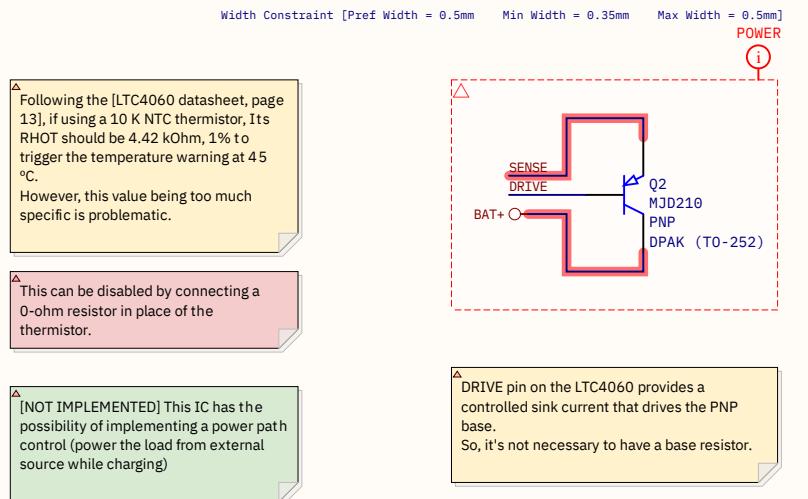
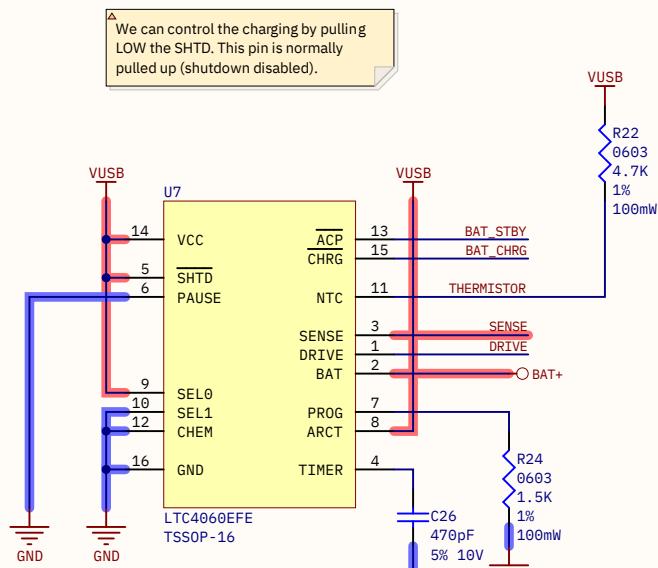
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NiMH/NiCd battery charger IC



TIMER capacitor and PROG resistor program the charge Tmax (maximum charging time, a security measure). [LTC4060 datasheet, page 13]. These values should complete a full charge in at most 1 h 6'.

PROG resistor programs the maximum current that the battery will receive while charging. For 1.5 k Ω this is 0.93 A.

i.e.: a 1000 mAh battery will charge at approx 1C with this configuration, but can be insufficient time for a 3000 mAh one.

Battery charging circuitry for Ni-MH

Battery charger circuit variant #1. By default the device uses a Nickel-metal hydride battery which are chemically and thermally more stable (and safer) than Lithium-based ones; at the cost of a lower charge/volume ratio.

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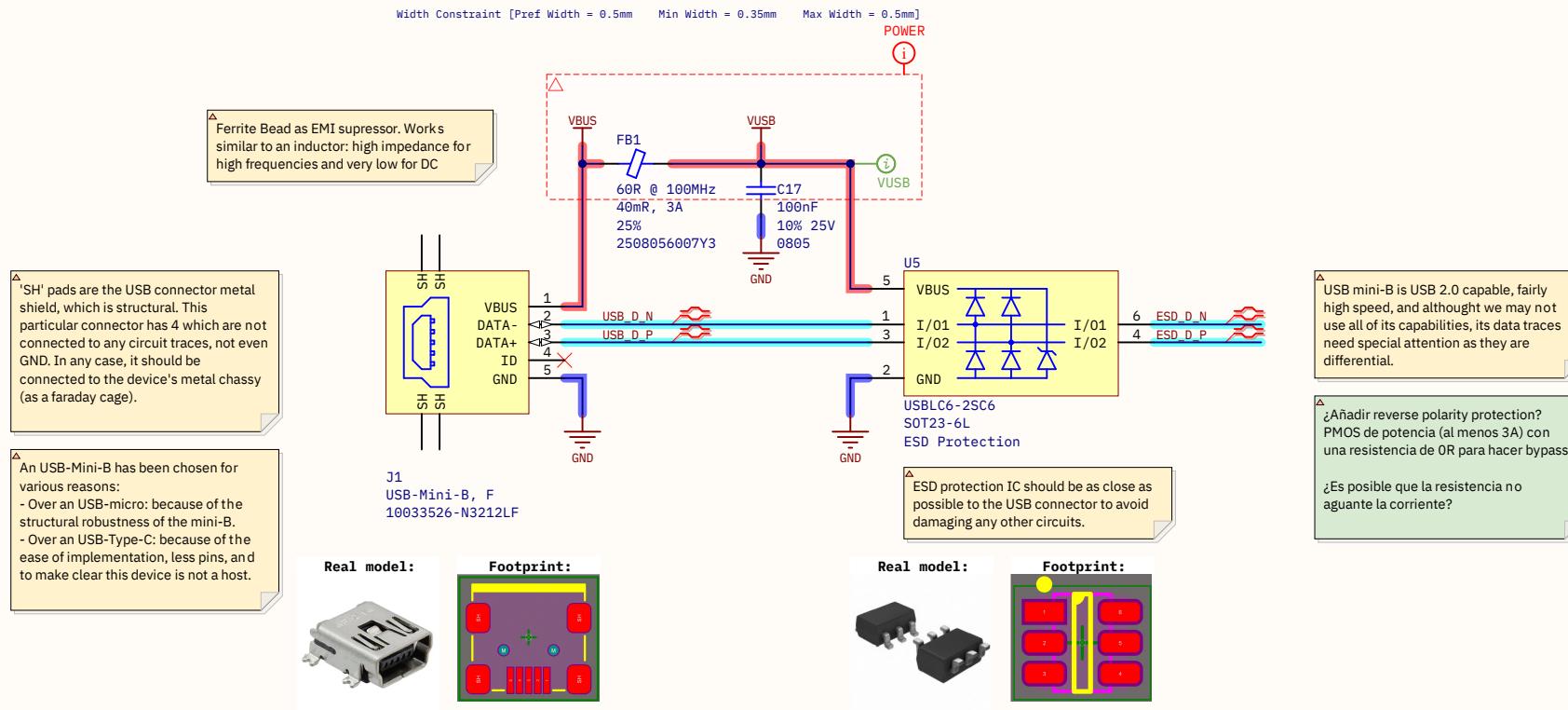
Sheet title: **Battery charger**
Project title: **TIK_HandheldDevice.PjPcb**

Designer: **Juan Del Pino Mena**

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USB connector and ESD protection circuit

USB is used as a programming interface, as well as a power source for the charging circuit. Since it's an external connector, it needs to have a protection circuit against electro-static discharge (ESD) and noise.

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Sheet title: **USB connector and ESD protection circuit**

Project title: **TIK_HandheldDevice.PxjPcb**

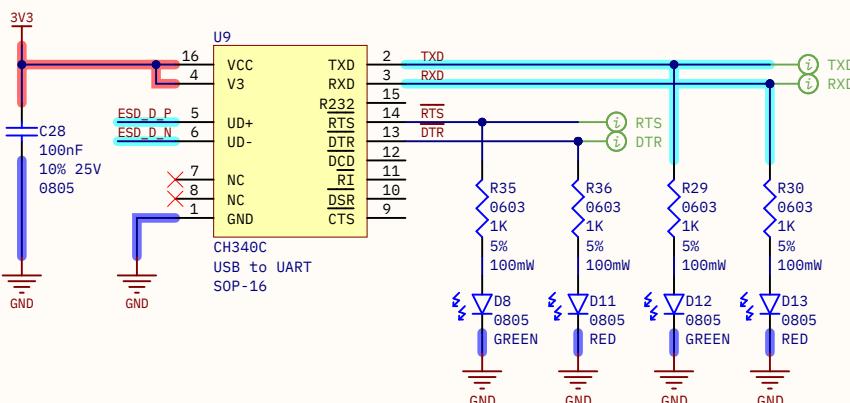
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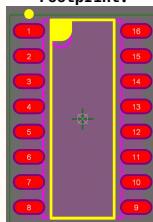
USB to UART conversion



Real model:

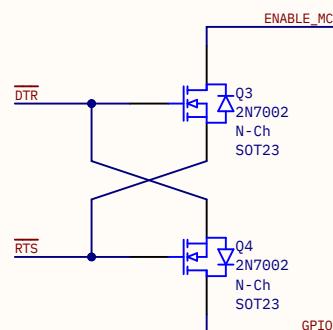


Footprint:



These LEDs serve as testimonies of
UART communication and help
during debugging process

Auto programming circuit



[△] ESP32 GPIO0 is a Strapping pin. Strapping pins modify the device's boot mode during chip reset (enable pin pulled down)
GPIO0 is pulled up during reset. ESP_ENABLE is pulled up by an external pullup resistor

When GPIO0 is HIGH, it boots from internal SPI memory, but when it's LOW the boot sequence changes to 'Download' and we can upload a program to the MCU.

[ESP32 Datasheet, section 2.4, pages 19-20]

Circuit truth table

DTR	RTS	ENABLE_MCU	GPIO0
0	0	1	1
0	1	1	0
1	0	0	1
1	1	1	1

USB to UART and MCU programming

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Supervisor's signature

Sheet title: **USB to UART and MCU programming**

Project title: **TIK_HandheldDevice.PjPcb**

Designer: **Juan Del Pino Mena**

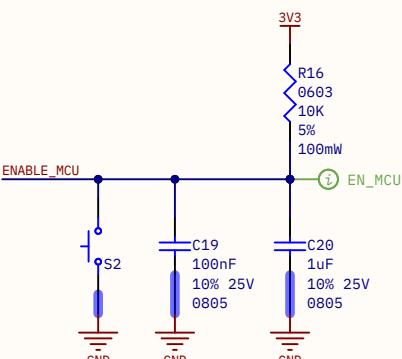
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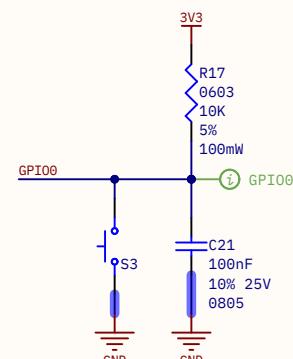


Reset

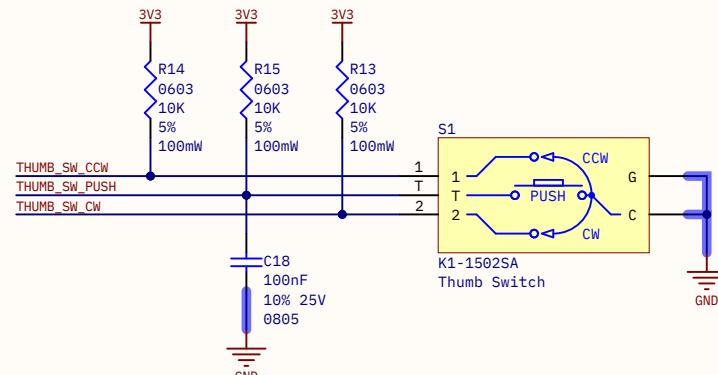
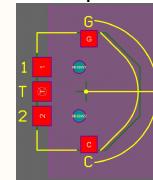
To ensure power stability to the microcontroller during powerup, this RC filter introduces a delay on the ENABLE pin. Usual values are $10\text{ k}\Omega$, $1\text{ }\mu\text{F}$ ($\tau = 10\text{ ms}$, $t_{\{10-90\}} = 22\text{ ms}$).
[ESP32-WROOM-32D datasheet, page 22]

**Boot mode selection (debug)**

Allows to force 'Download' boot sequence
Same design as in ESP32 DevKit boards.
100 nF cap are for debouncing and should be placed close to the buttons

**Multidirection 'thumb' button (UI navigation)**

Horizontal SMD device, multi-directional / muti-function rotary slider button.
Accessed from the right side.

**Real model:****Footprint:****Buttons**

TFT LCD touchscreen, rotary encoder, on/off and reset switches

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Designer's signature
Supervisor's signature

Sheet title: **Buttons**
Project title: **TIK_HandheldDevice.PjPcb**

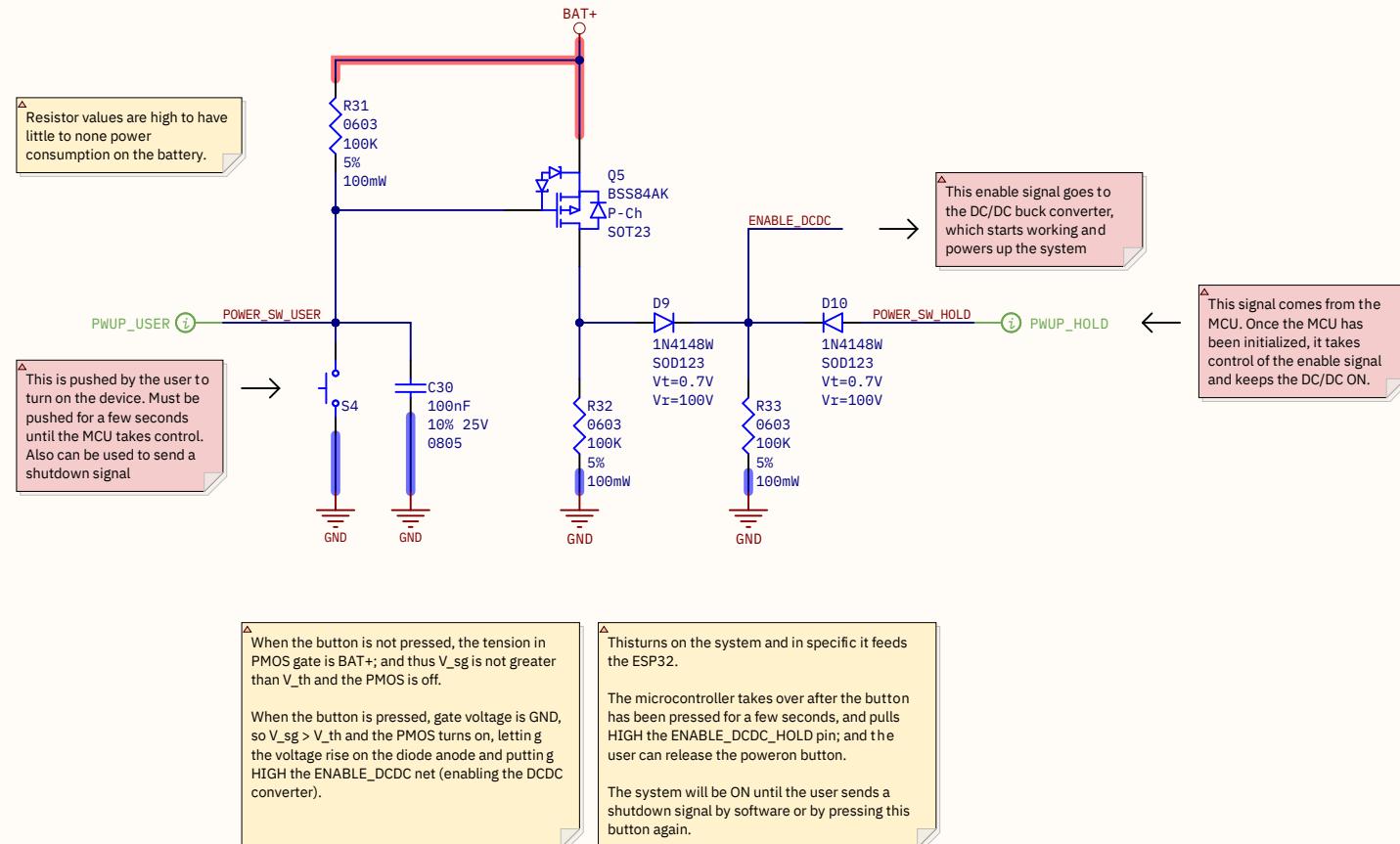
Designer: **Juan Del Pino Mena**

Date: **2022-04-28** Revision: **0.3** Sheet 13 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología
de Computadores
University of Granada
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A



Powerup button

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Designer's signature
Supervisor's signature

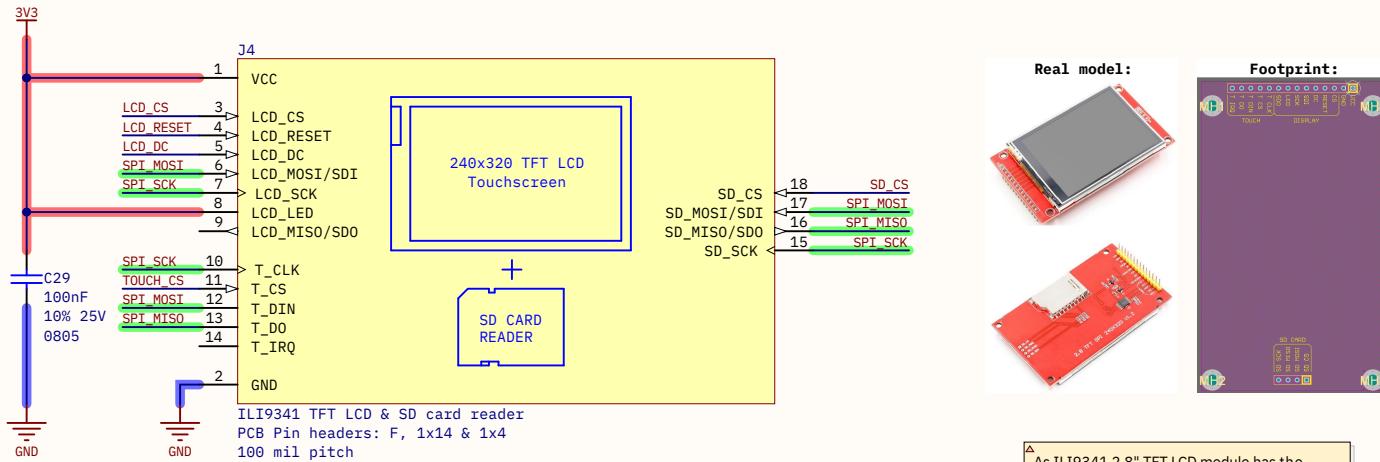
Sheet title: **Powerup button**
Project title: **TIK_HandheldDevice.PjPcb**

Designer: **Juan Del Pino Mena**

Date: **2022-04-28** Revision: **0.3** Sheet 14 of 18

Supervisor:
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LCD TFT Touch Display & SD card reader

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Designer's signature

Supervisor's signature

Sheet title: LCD TFT Touch Display & SD card reader

Project title: TIK_HandheldDevice.PjPcb

Designer: Juan Del Pino Mena

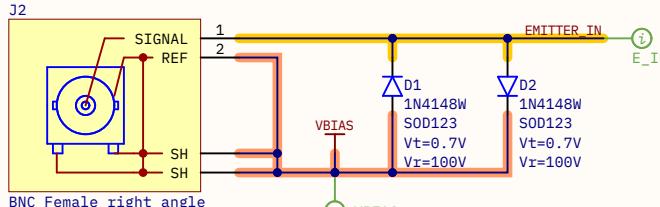
Date: 2022-04-28 Revision: 0.3 Sheet 15 of 18

Supervisor:
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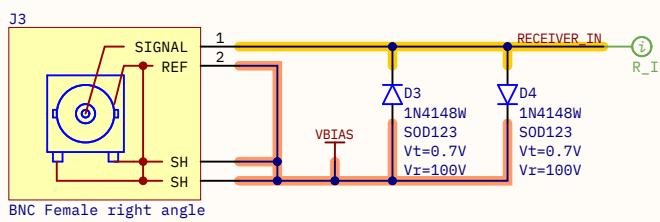


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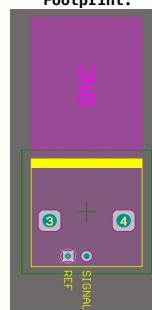
Width Constraint [Pref Width = 0.8mm] Min Width = 0.35mm Max Width = 0.8mm
Matched Net Lengths [Tolerance = 0.05mm]



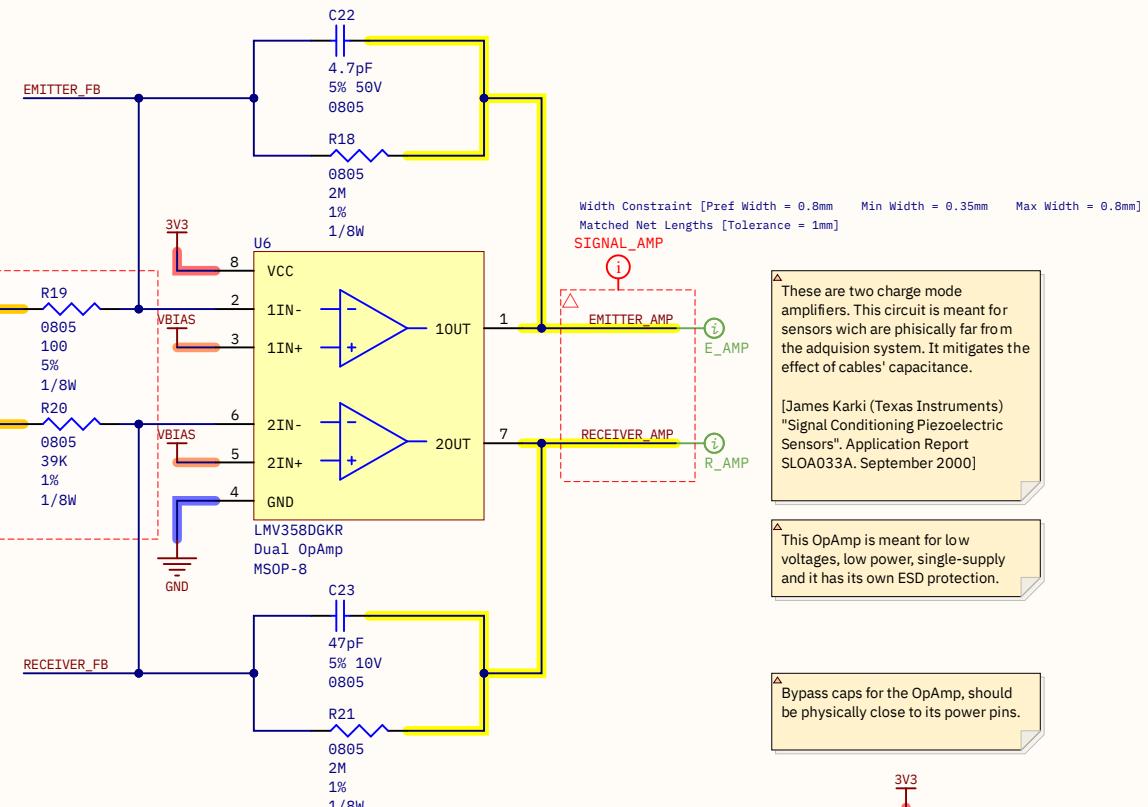
Real model:



Footprint:



Emitter signal will be in the range of 15 V to 100 V and need to be clipped. Then the OpAmp will amplify by perceived by the instrument as a flank; whereas receiver signal most likely will be amplified without any clipping.

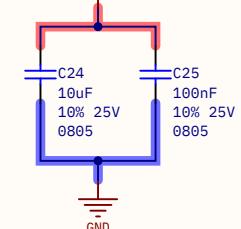


These are two charge mode amplifiers. This circuit is meant for sensors which are physically far from the acquisition system. It mitigates the effect of cables' capacitance.

[James Karki (Texas Instruments)
"Signal Conditioning Piezoelectric
Sensors". Application Report
SLOA033A. September 2000]

▲ This OpAmp is meant for low voltages, low power, single-supply and it has its own ESD protection.

► Bypass caps for the OpAmp, should be physically close to its power pins.



Signal conditioning circuit

Signal comes from piezoelectric sensors and need to be converted from charge to voltage. Tree sensors that have been used for this project proved to generate upto -100 volts peak, so it needs clipping

Designer's signature	
Supervisor's signature	

Chapter 11: Object-Oriented Programming

Brought to you by | TTK_H_II_3/Davidson, B. [IP]

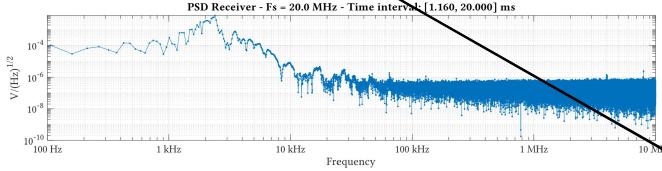
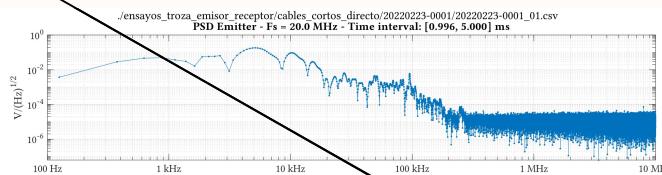
Digitized by srujanika@gmail.com

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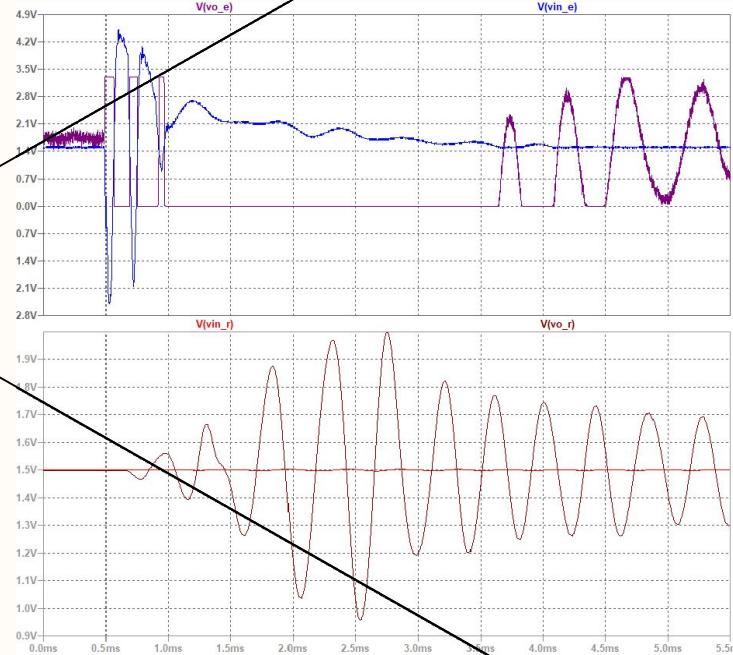


Example of a Voltage Spectral Density of trunk signals

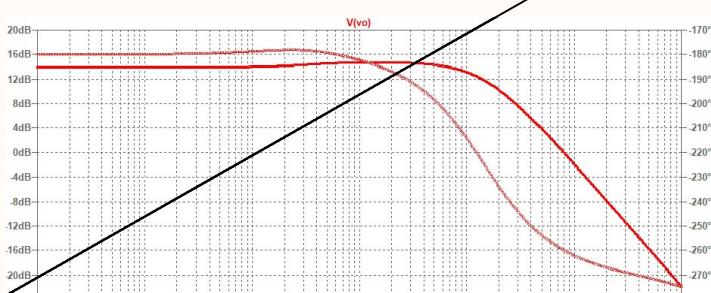
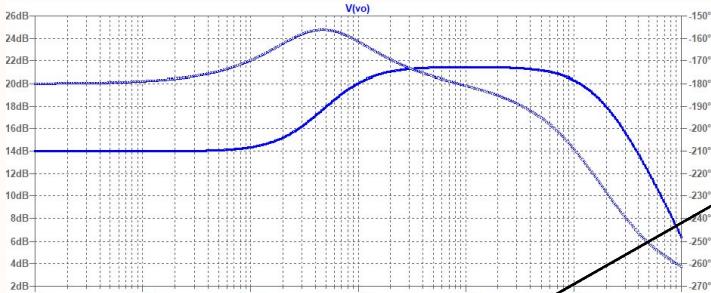


A REVISAR Y REPETIR EN ALTIUM

Time behavior



Conditioning circuit theoretical frequency response



Respuesta en frecuencia teórica, con el modelo UniversalOpAmp, cable con 700 pF y R del piezo 2 M Ω
¿Afecta en algo la fase?

Signal conditioning theoreticals

*
*

TO-DO

Designer's signature
Supervisor's signature

Sheet title: Signal Conditioning Theoreticals

Project title: TIK_HandheldDevice.PxjPcb

Designer: Juan Del Pino Mena

Date: 2022-04-28 Revision: 0.3

Sheet 17 of 18

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B

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C

D

D

Power budget

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Designer's signature

Supervisor's signature

Sheet title: **Power budget**

Project title: **TIK_HandheldDevice.PxjPcb**

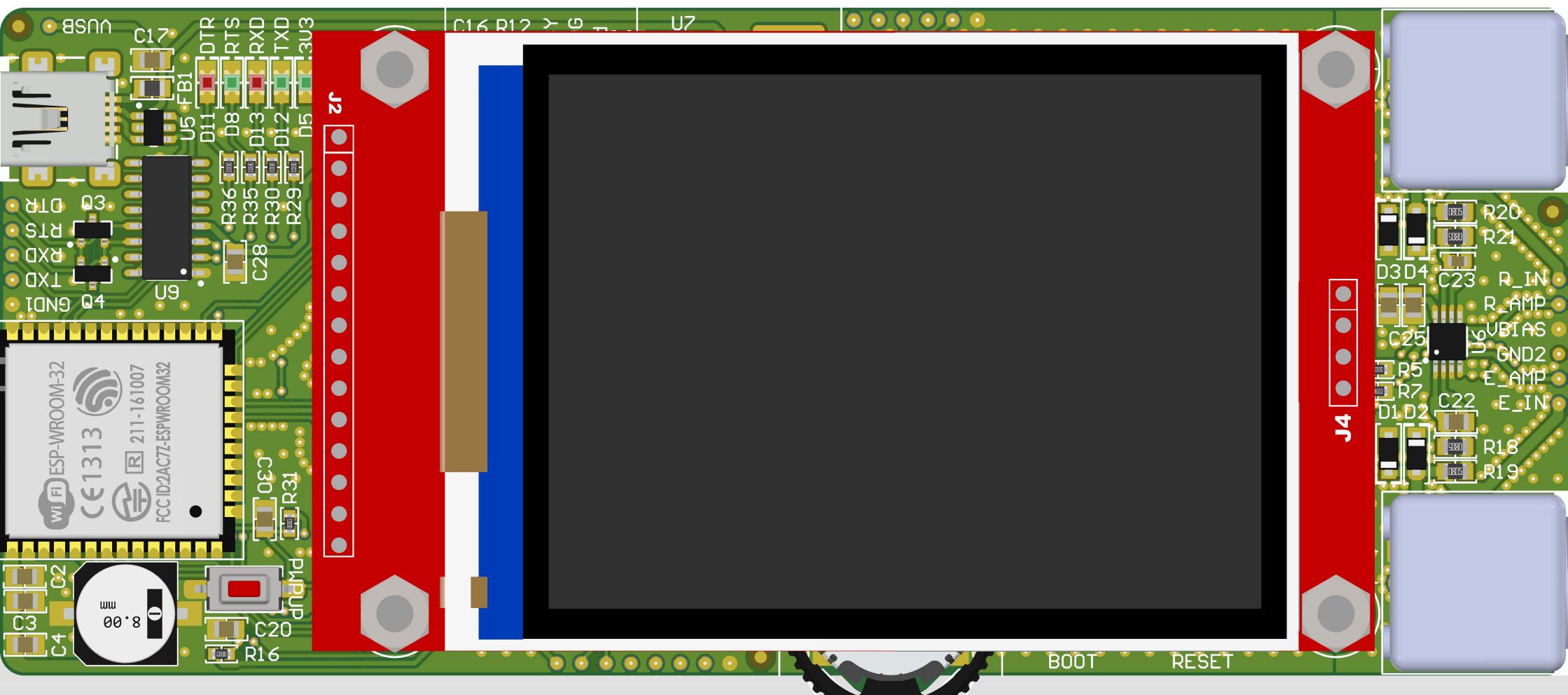
Designer: **Juan Del Pino Mena**

Date: **2022-04-28** Revision: **0.3**

Sheet 18 of 18

Supervisor:
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RECEIVER
[STOP]

EMITTER
[START]

TIK handheld device

2022-04-28 rev 0.3

Juan Del Pino Mena github.com/dpmj



THUMB BUTTON

SD CARD SLOT

BAT_STBY
BAT_CHRG
UBAT+
UBAT-
UIMEAS
GND4

R_IN
R_AMP
UBIAS
GND2
E_AMP
E_IN
SD CS
SD SCK
SD MOSI
SD MISO

GND3
EN_LDO
EN_DCDC
PWRUP_USER
PWRUP_HOLD
EN MCU
GPIO0
3V3

DISPLAY

UCC
GND
CS
RESET
DC
SDI
SCK

LED
SDO
T_CLK
T_CS
T_DIN
T_DO
T_IRQ



✓ RoHS
Pb-free



ATTENTION
ELECTROSTATIC
SENSITIVE
DEVICE

USB

USB

ESP32 ANTENNA

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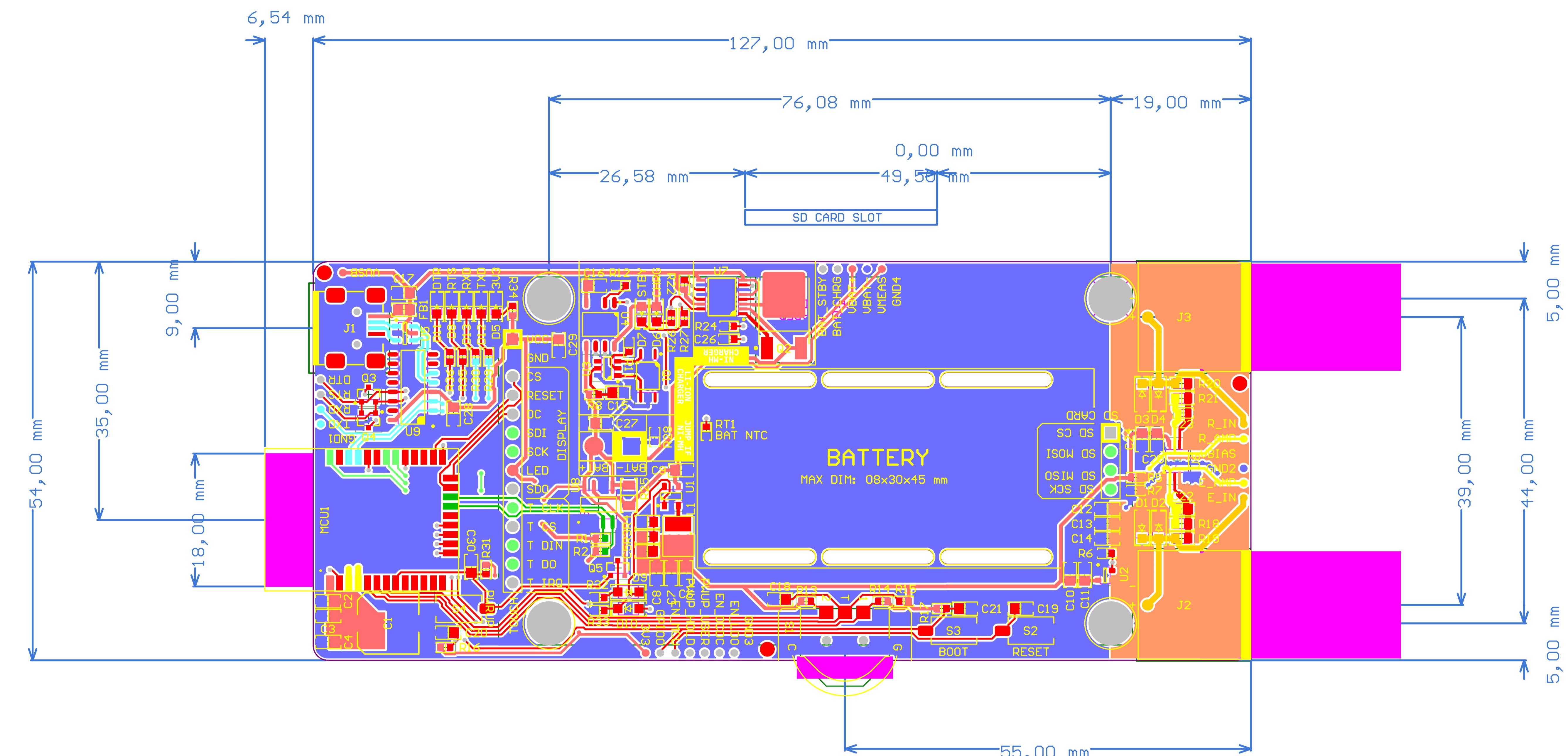
B

C

C

D

D



TIK handheld device PCB

PCB orientation: vertical. Screen facing front, BNCs on top, USB at the bottom, SD Card reader at the left, powerup button at the bottom front right, and multipurpose button on the right side.

Designer's signature:

Sheet title: TIK Handheld Device PCB

Project title: TIK_HandheldDevice

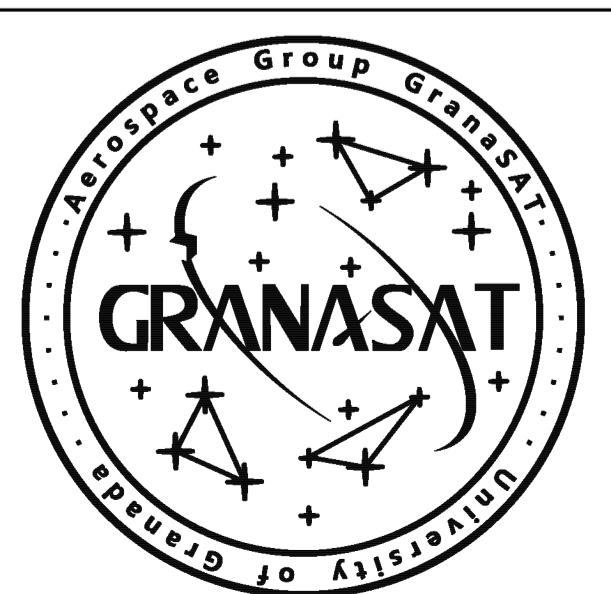
Supervisor's signature:

Designer: Juan Del Pino Mena

Supervisor: Andres Roldan Aranda

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Sr. Andres Roldan Aranda

Date: 2022-04-28
Revision: 0.3 Sheet 1 of 1



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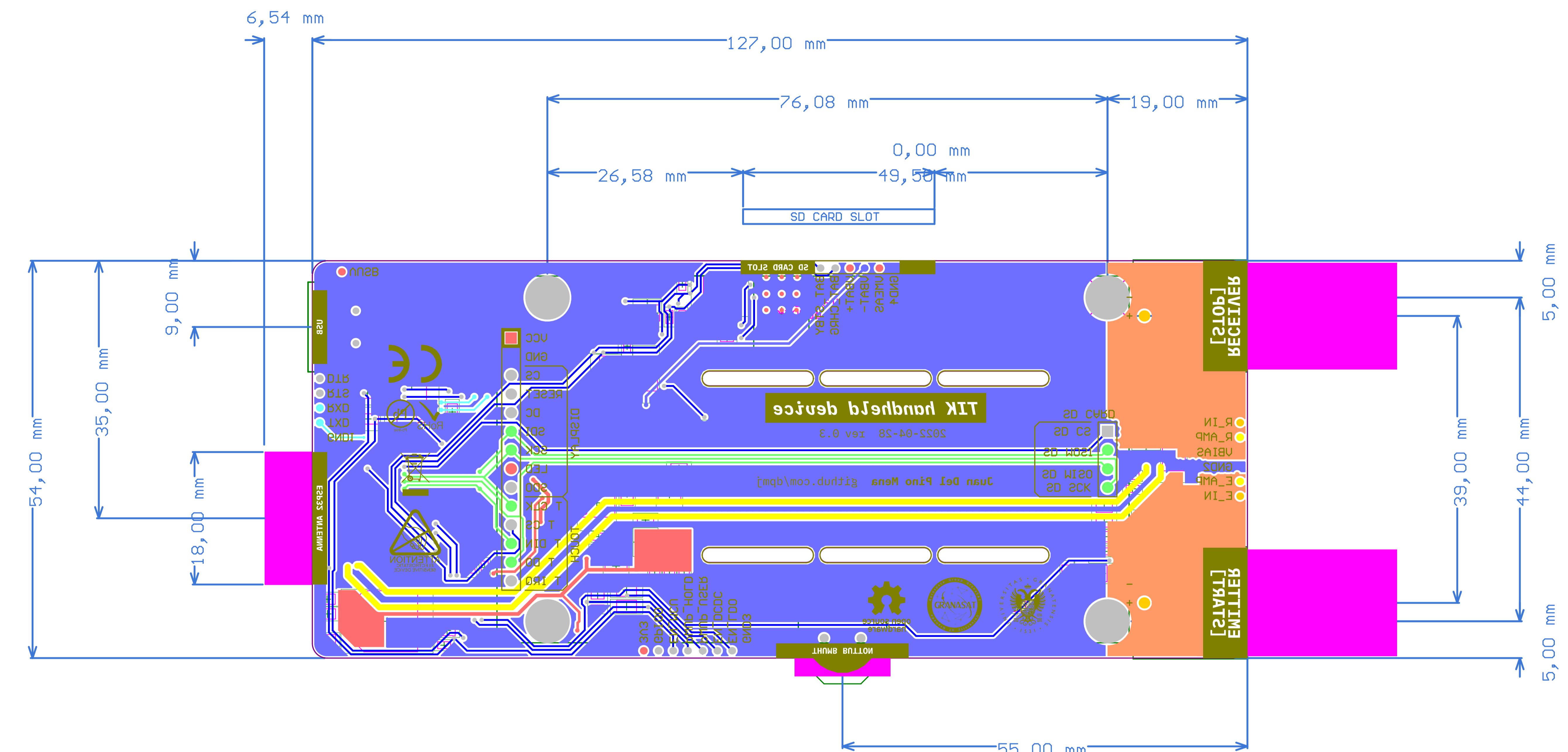
B

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D



TIK handheld device PCB

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Sheet title: TIK Handheld Device PCB

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Supervisor's signature:

Project title: TIK_HandheldDevice

Designer: Juan Del Pino Mena

Supervisor: Andres Roldan Aranda

